

# THYRISTOR MODULE

## PBH308AC

30A / 800V

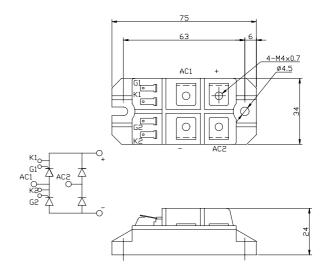
OUTLINE DRAWING

### **FEATURES**

- \* Isolated Base
- \* Thyristors and Diodes H-Bridge Circuit
- \* High Surge Capability
- \* UL Recognized, File No. E187184

#### TYPICAL APPLICATIONS

\* Rectified For General Use



### Maximum Ratings

### Approx Net Weight:70g

D	Symbol	Grade		
Parameter		PBH308AC	Unit	
Repetitive Peak Off-State Voltage	V <sub>DRM</sub>	800	17	
Non Repetitive Peak Off-State Voltage	V <sub>DSM</sub>	960	1 V	
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	800	W	
Non Repetitive Peak Reverse Voltage	Vrsm	960	] <b>v</b>	

Para	meter		Condi	Max Rated Value	Unit	
Average Rectified C	Output Current	Io(AV)	50Hz Half Sine \\Tc=94℃	30	A	
Surge On-State Cu	rrent	ITSM	50 Hz Half Sine Non-Repetitive	600	A	
I Squared t		I <sup>2</sup> t	2msec to 10msec	1800	$A^2s$	
Critical Rate of Tu	rned-On Current	di/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> , I <sub>TM</sub> =2·I <sub>O</sub> , Tj=125°C I <sub>G</sub> =200mA, dic/dt=0.2A/µs		100	A/μs
Peak Gate Power		P <sub>GM</sub>			5	W
Average Gate Powe	r	P <sub>G(AV)</sub>			1	W
Peak Gate Current		$I_{GM}$			2	Α
Peak Gate Voltage		$V_{GM}$			10	V
Peak Gate Reverse	Voltage	Vrgm			5	V
Operating Junction'	Temperature Range	Tjw			-40 to +125	$^{\circ}\mathrm{C}$
Storage Temperatur	re Range	Tstg			-40 to +125	$^{\circ}\mathrm{C}$
Isoration Voltage		Viso	Base Plate to Terminals, AC1min		2500	V
Mounting torque	Case mounting	Ftor	Greased	M4 Screw	0.9 to 1.6	N•m
	Terminals		-	M4 Screw	1.3 to 1.9	1 N•111
Gate Terminals Treatment Force		Ftor	Insertion/F	45/32	N	

Value per 1 Arm

# Nihon Inter Electronics Corporation

Electrical • Thermal Characteristics

Characteristics	Symbol	Test Conditions		Maximum Value.			Unit
Characteristics	Symbol			Min.	Тур.	Max.	Oilit
Peak Off-State Current	$I_{DM}$	V <sub>DM</sub> = V <sub>DRM</sub> , Tj= 125°C				10	mA
Peak Reverse Current	$I_{RM}$	V <sub>RM</sub> = V <sub>RRM</sub> , Tj= 125°C				10	mA
Peak Forward Voltage	$V_{TM}$	I <sub>TM</sub> = 90A, Tj=25°C				1.45	V
Gate Current to Trigger	I <sub>GT</sub>	V <sub>D</sub> =6V,I <sub>T</sub> =1A	Tj=-40°C			200	mA
			Tj=25°C			100	
			Tj=125°C			50	
Gate Voltage to Trigger	V <sub>GT</sub>	V <sub>D</sub> =6V,I <sub>T</sub> =1A	Tj=-40°C			4	V
			Tj=25°C			2.5	
			Tj=125°C			2	
Gate Non-Trigger Voltage	$V_{\mathrm{GD}}$	V <sub>D</sub> =2/3V <sub>DRM</sub> Tj=125°C		0.25			V
Critical Rate of Rise of Off-State	dv/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Tj=125°C		500			V/µs
Voltage		ű					•
Turn-Off Time	tq	I <sub>TM</sub> =I <sub>O</sub> ,V <sub>D</sub> =2/3V <sub>DRM</sub> dv/dt=20V/μs, V <sub>R</sub> =100V -di/dt=20A/μs, Tj=125°C			100		μs
Turn-On Time	tgt	V <sub>D</sub> =2/3V <sub>DRM</sub> Tj=125°C I <sub>G</sub> =200mA, di <sub>G</sub> /dt=0.2A/μs			6		μs
Delay Time	td				2		μs
Rise Time	tr				4		μs
Latching Current	$I_{L}$	Tj=25°C			100		mA
Holding Current	$I_{H}$	Tj=25°C			50		
Thermal Resistance *1	Rth(j-c)	Junction to Case Base Plate to Heat Sink with Thermal Compound				0.44	°C/W
	Rth(c-f)					0.1	

Value Per 1Arm \*1:Value Per Module

# Nihon Inter Electronics Corporation

# PBH308AC OUTLINE DRAWING (Dimensions in mm)

